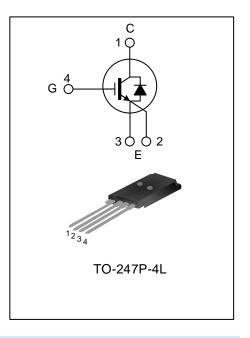
75A, 1200V FIELD STOP IGBT

DESCRIPTION

The SGTP75V120FDB2PW4 field stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

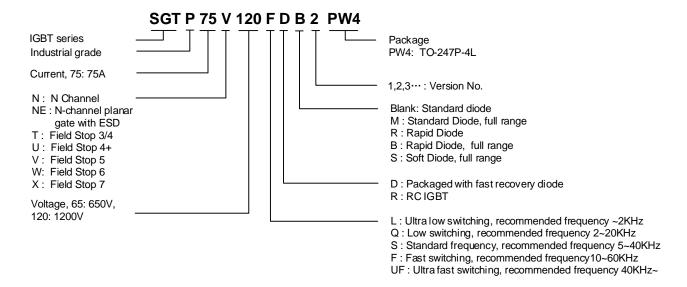
FEATURES

- ◆ 75A, 1200V, V_{CE(sat)(typ.)}=1.9V@I_C=75A
- Low conduction loss
- Ultra-fast switching
- High input impedance
- T_{Jmax}=175°C



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NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking Hazardous Substance Control		Packing Type	
SGTP75V120FDB2PW4	TO-247P-4L	P75V120FDB2	Halogen free	Tube	

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, Tc=25°C)

Charact	teristics	Symbol	Ratings	Unit
Collector to Emitter	Voltage	V _{CE}	1200	V
Gate to Emitter Vol	tage	V_{GE}	±20	V
Transient Gate-Emi (t _p ≤10µs, D<0.010	•	V _{GE}	±30	V
Collector Current	T _C =25°C	I _C	150	Α
	T _C =100°C		75	А
Pulsed Collector Current		Ісм	300	Α
Diode Current	T _C =25°C	l _F	150	Α
	T _C =100°C		75	A
Pulsed Diode Current		I _{FM}	300	Α
Power Dissipation (T _C =25°C)		P _D	833	W
Operating Junction Temperature		TJ	-40∼+175	°C
Storage Temperature Range		T _{stg}	-55∼+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	Rejc				0.18	°C/W
(IGBT)	IXAJC				0.10	C/VV
Thermal Resistance, Junction to Case	D				0.40	0000
(FRD)	R _{eJC}				0.40	°C/W
Thermal Resistance, Junction to	В				40	0000
Ambient (IGBT)	$R_{\theta JA}$				40	°C/W
Soldering Temperature (in line)	T _{sold}	15 ⁺² -0 sec, 1time			260	°C

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ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =250μA	1200			V
C-E Leakage Current	I _{CES}	V _{CE} =1200V, V _{GE} =0V			400	μA
G-E Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			±600	nA
G-E Threshold Voltage	$V_{GE(th)}$	I _C =250μA, V _{CE} =V _{GE}	4.3	5.3	6.4	V
Collector to Emitter	\/	I _C =75A, V _{GE} =15V, T _C =25°C		1.9	2.5	V
Saturation Voltage	$V_{CE(sat)}$	I _C =75A, V _{GE} =15V, T _C =150°C		2.5		V
Input Capacitance	C _{ies}	V 20V		7300		
Output Capacitance	C _{oes}	V _{CE} =30V		175		nE
Reverse Transfer Capacitance	C _{res}	V _{GE} =0V f=1MHz		23		pF
Turn-On Delay Time	T _{d(on)}			56		ns
Rise Time	Tr	$\begin{array}{c} V_{CE}=600V \\ I_{C}=75A \\ R_{g}=10\Omega \\ V_{GE}=15V \\ \text{inductive load} \\ T_{C}=25^{\circ}C \end{array}$		31		
Turn-Off Delay Time	$T_{d(off)}$			190		
Fall Time	T _f			27		
Turn-On Switching Loss	Eon			3.70		
Turn-Off Switching Loss	E _{off}			2.17		mJ
Total Switching Loss	E _{st}			5.87		
Turn-On Delay Time	T _{d(on)}	V 000V		53		
Rise Time	Tr	V _{CE} =600V		21		
Turn-Off Delay Time	T _{d(off)}	I _C =37.5A		204		ns
Fall Time	T _f	$R_g=10\Omega$		26		
Turn-On Switching Loss	Eon	V _{GE} =15V inductive load T _C =25°C		1.23		
Turn-Off Switching Loss	E _{off}			1.07		mJ
Total Switching Loss	E _{st}			2.30		
Total Gate Charge	Qg			234		
Gate to Emitter Charge	Q_ge	V _{CE} =600V, I _C =75A, V _{GE} =15V		67		nC
Gate to Collector Charge	Q_{gc}			68		

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ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, Tc=25°C)

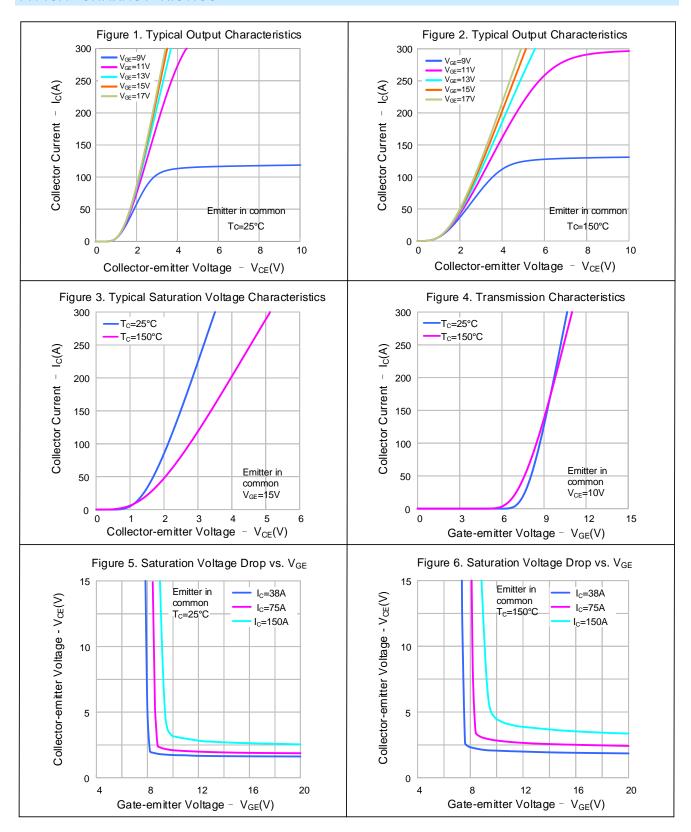
Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	V	I _F =75A, T _C =25°C		3.0	3.8	V
	V_{FM}	I _F =75A, T _C =150°C		2.6		
Diode Reverse Recovery	T _{rr} Q _{rr}			63		ns
Time						
Diode Reverse Recovery		I _{ES} =75A, dI _{ES} /dt=200A/μs, T _C =25°C		260		nC
Charge						iiC
Diode Reverse Recovery	Irrm			7.6		Α
Current						

ELECTRICAL CHARACTERISTICS OF IGBT (Tc=150°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-On Delay Time	T _{d(on)}	V 000V		53		ns
Rise Time	Tr	V _{CE} =600V		36		
Turn-Off Delay Time	T _{d(off)}	I _C =75A		218		115
Fall Time	T _f	$R_g=10\Omega$		41		
Turn-On Switching Loss	Eon	V _{GE} =15V inductive load		4.36		
Turn-Off Switching Loss	E _{off}			3.01		mJ
Total Switching Loss	E _{st}	- T _C =150°C		7.37		
Turn-On Delay Time	T _{d(on)}	V 000V		49		
Rise Time	Tr	V _{CE} =600V		23		20
Turn-Off Delay Time	$T_{d(off)}$	I_{C} =37.5A $ R_{g}$ =10 Ω $ V_{GE}$ =15 V $-$ inductive load $ T_{C}$ =150°C $-$		258		ns
Fall Time	T _f			40	-	
Turn-On Switching Loss	E _{on}			1.46		
Turn-Off Switching Loss	E _{off}			1.58		mJ
Total Switching Loss	E _{st}	10-100 0		3.04		

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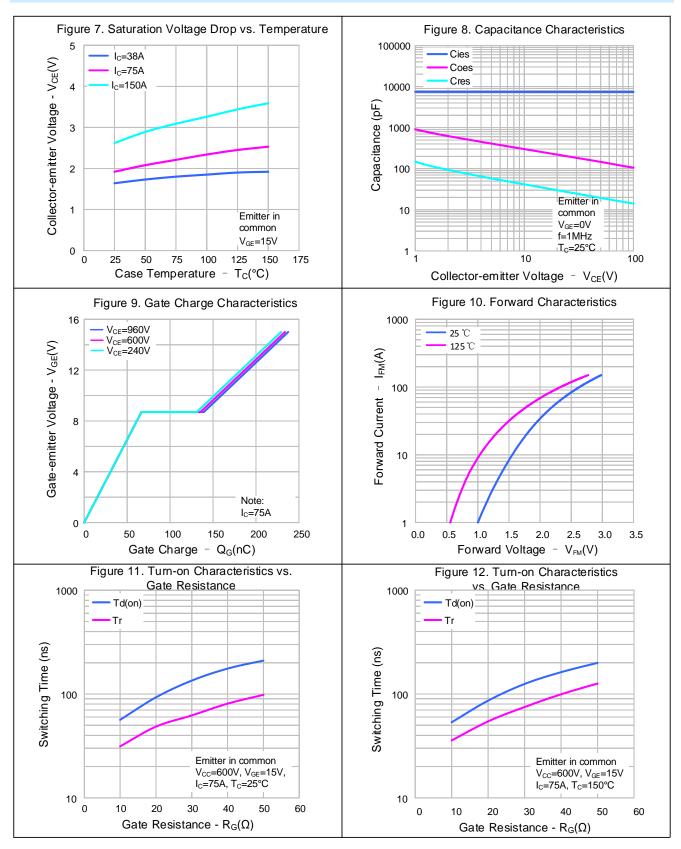
TYPICAL CHARACTERISTICS



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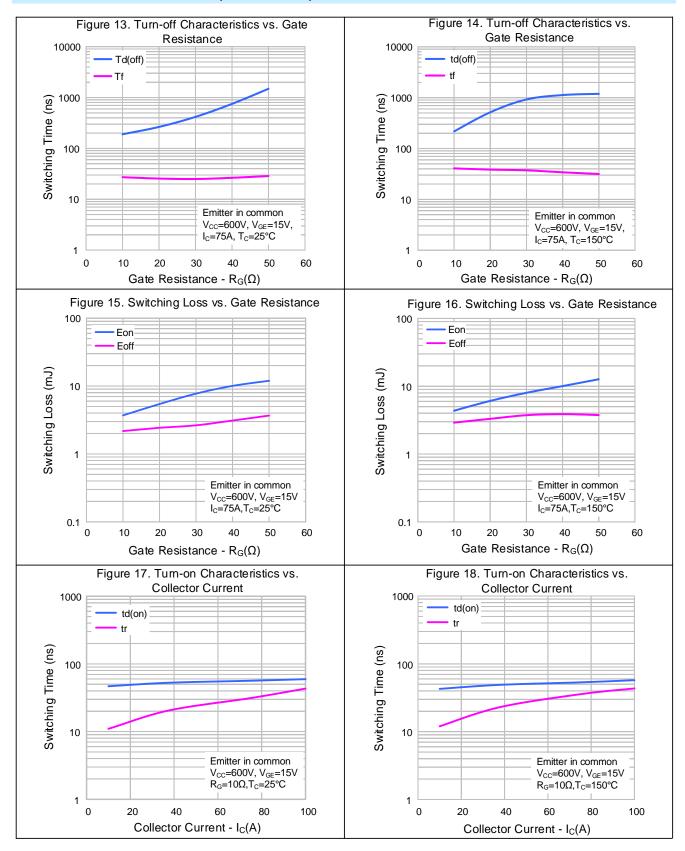
TYPICAL CHARACTERISTICS (CONTINUED)



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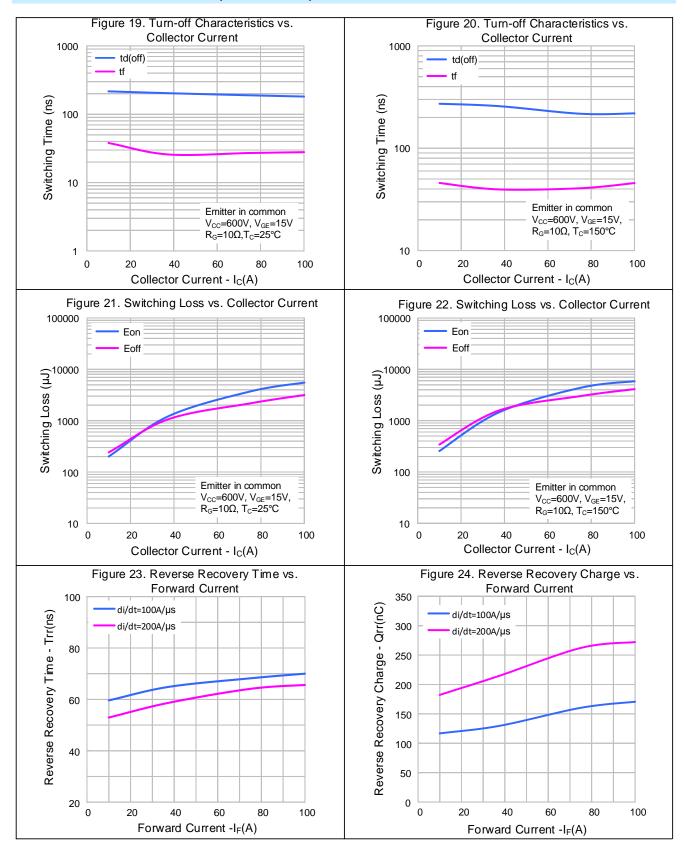
TYPICAL CHARACTERISTICS (CONTINUED)



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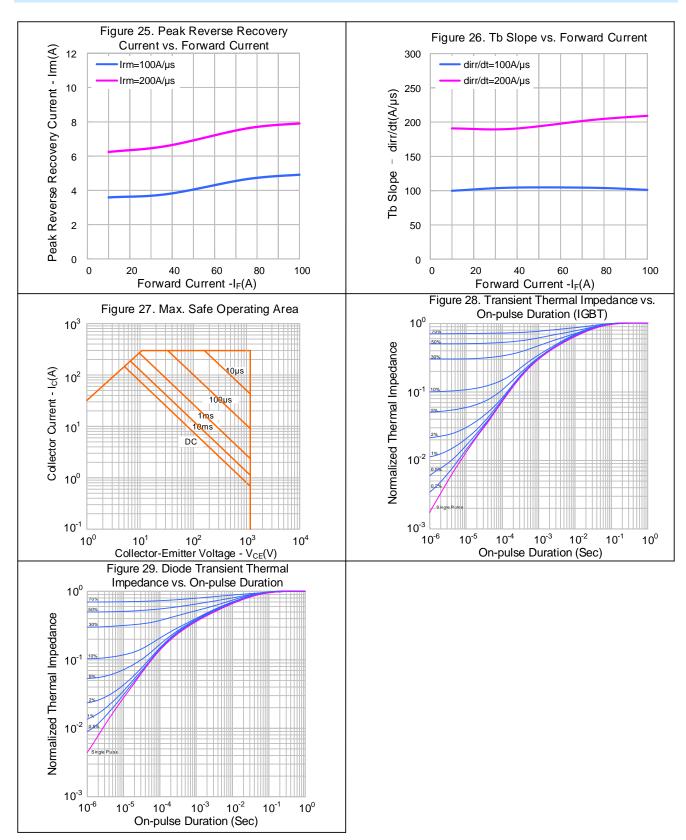
TYPICAL CHARACTERISTICS (CONTINUED)



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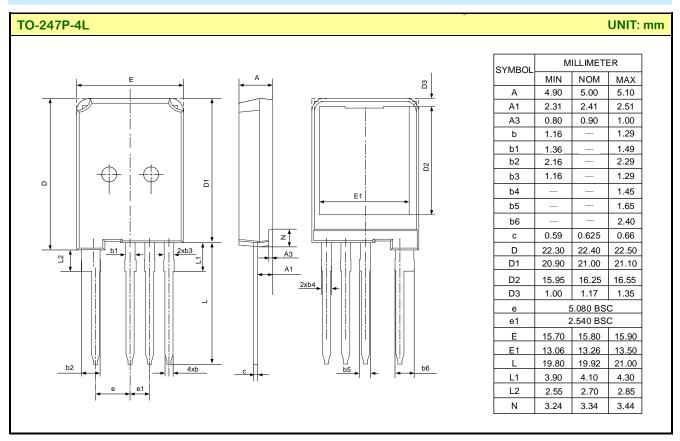
TYPICAL CHARACTERISTICS (CONTINUED)



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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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1.0 Rev.: Revision History:

First release

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